

# IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

## In re Application of :

Wai Lo  
David Chan



Serial No. : 10/702,165

Group Art Unit : 2824

Filed : November 04, 2003

Examiner : Smith, Bradley

For : Thin Film CMOS Calibration  
Standard Having Protective Cover  
Layer

Atty Docket : LSI1P191D1 / 02-0186/1D

I hereby certify that this correspondence is being deposited with the U.S. Postal Service as First Class Mail in an envelope addressed to: Commissioner for Patents, P. O. Box 1450, Alexandria, VA 22313-1450, on the date below:

Mark Salvatore

September 30, 2004

Date

Signature

## **SUBMISSION OF FORMAL DRAWINGS PURSUANT TO 37 C.F.R. §1.85**

### **Official Draftsman**

Commissioner for Patents  
P. O. Box 1450  
Alexandria, VA 22313-1450

Sir:

Applicant hereby substitutes the enclosed formal drawings for those presently in the above referenced application.

LSI Logic Corporation  
1621 Barber Lane, MS D-106  
Milipitas, CA 95035  
408-433-7475

Date: 28 Sept 04

Respectfully submitted,

Timothy Croll

Reg. No. 36,771